GD150HFT120C2S IGBT Module

## **STARPOWER**

SEMICONDUCTOR™

**IGBT** 

## **GD150HFT120C2S**

**Preliminary** 

**Molding Type Module** 

1200V/150A 2 in one-package

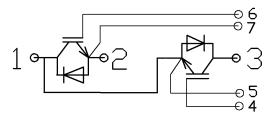


### **General Description**

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

#### **Features**

- Low V<sub>CE(sat)</sub> trench IGBT technology
- Low switching losses
- 10µs short circuit capability
- Maximum junction temperature 175 ℃
- V<sub>CE(sat)</sub> with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



**Equivalent Circuit Schematic** 

### **Typical Applications**

- AC inverter drives
- Switching mode power supplies
- Electronic welders

### Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

| Symbol    | Description               | GD150HFT120C2S | Units |
|-----------|---------------------------|----------------|-------|
| $V_{CES}$ | Collector-Emitter Voltage | 1200           | V     |

| Symbol                       | Description                                  | GD150HFT120C2S | Units                  |
|------------------------------|--|----------------|------------------------|
| $V_{GES}$                    | Gate-Emitter Voltage                         | ±20            | V                      |
| T                            | Collector Current @ T <sub>C</sub> =25°C     | 255            | Δ.                     |
| $I_{C}$                      | @ T <sub>C</sub> =80°C                       | 150            | A                      |
| $I_{CM(1)}$                  | Pulsed Collector Current t <sub>p</sub> =1ms | 300            | A                      |
| $I_{\mathrm{F}}$             | Diode Continuous Forward Current             | 150            | A                      |
| $I_{FM}$                     | Diode Maximum Forward Current                | 300            | A                      |
| $P_{D}$                      | Maximum Power Dissipation @ $T_j=175$ °C     | 1000           | W                      |
| $T_{SC}$                     | Short Circuit Withstand Time @ $T_j=125$ °C  | 10             | μs                     |
| $T_{\rm j}$                  | Maximum Junction Temperature                 | 175            | $^{\circ}\!\mathbb{C}$ |
| $T_{STG}$                    | Storage Temperature Range                    | -40 to +125    | $^{\circ}\!\mathbb{C}$ |
| I <sup>2</sup> t-value,Diode | $V_R=0V,t=10ms,T_j=125$ °C                   | 4500           | $A^2s$                 |
| $V_{\rm ISO}$                | Isolation Voltage RMS,f=50Hz,t=1min          | 2500           | V                      |
| Mounting Torque              | Power Terminal Screw:M6                      | 2.5 to 5.0     | N.m                    |
| Mounting Torque              | Mounting Screw:M6                            | 3.0 to 5.0     | N.m                    |

#### **Notes:**

(1) Repetitive rating: Pulse width limited by max. junction temperature

## Electrical Characteristics of IGBT $_{T_{C}\!=\!25\,^{\circ}\!C}$ unless otherwise noted

### **Off Characteristics**

| Symbol               | Parameter                 | Test Conditions  | Min. | Тур. | Max. | Units |
|----------------------|---------------------------|--|------|------|------|-------|
| V <sub>(BR)CES</sub> | Collector-Emitter         | $V_{GE}=0V, I_{C}=250\mu A,$                                 | 1200 | 200  |      | 17    |
|                      | Breakdown Voltage         | $V_{GE}$ =0V, $I_{C}$ =250 $\mu$ A, $T_{j}$ =25 $^{\circ}$ C | 1200 |      |      | V     |
| I <sub>CES</sub>     | Collector Cut-Off Current | $V_{\text{CE}}=V_{\text{CES}}, V_{\text{GE}}=0V,$            |      |      | 5.0  | A     |
|                      |                           | T <sub>j</sub> =25℃  |      | 3.0  | mA   |       |
| $I_{GES}$            | Gate-Emitter Leakage      | $V_{GE}=V_{GES}, V_{CE}=0V,$                                 |      | 400  |      | nA    |
|                      | Current                   | $T_j=25^{\circ}C$  |      |      | 400  |       |

#### **On Characteristics**

| Symbol               | Parameter                         | Test Conditions                                    | Min. | Тур. | Max. | Units |
|----------------------|-----------------------------------|--|------|------|------|-------|
| $V_{\text{GE(th)}}$  | Gate-Emitter Threshold<br>Voltage | $I_{C}=3.5$ mA, $V_{CE}=V_{GE}$ ,<br>$T_{j}=25$ °C | 5.0  |      | 7.5  | V     |
| V <sub>CE(sat)</sub> | Collector to Emitter              | $I_{C}=150A, V_{GE}=15V,$ $T_{j}=25^{\circ}C$      |      | 2.00 | 2.30 | V     |
|                      | Saturation Voltage                | $I_{C}=150A, V_{GE}=15V,$ $T_{j}=175^{\circ}C$     |      | 2.60 |      |       |

## **Switching Characteristics**

| Symbol       | Parameter Test Conditions |                                  | Min. | Тур. | Max. | Units |
|--------------|---------------------------|----------------------------------|------|------|------|-------|
| $t_{d(on)}$  | Turn-On Delay Time        | $V_{CC}=600V, I_{C}=150A,$       |      | 65   |      | ns    |
| $t_r$        | Rise Time                 | $R_G=2.3\Omega, V_{GE}=\pm 15V,$ |      | 120  |      | ns    |
| $t_{d(off)}$ | Turn-Off Delay Time       | T <sub>j</sub> =25℃              |      | 300  |      | ns    |

| $t_{\rm f}$          | Fall Time                                   |   | 120  |    | ns |
|----------------------|---|---|------|----|----|
| Eon                  | Turn-On Switching Loss                      | $V_{CC}$ =600V, $I_{C}$ =150A,<br>$R_{G}$ =2.3 $\Omega$ , $V_{GE}$ = $\pm$ 15V,                               | 15.4 |    | mJ |
| E <sub>off</sub>     | Turn-Off Switching Loss                     | T <sub>j</sub> =25°C  | 9.2  |    | mJ |
| t <sub>d(on)</sub>   | Turn-On Delay Time                          |   | 65   |    | ns |
| t <sub>r</sub>       | Rise Time                                   |   | 120  |    | ns |
| t <sub>d(off)</sub>  | Turn-Off Delay Time                         | V (00VI 150A  | 350  |    | ns |
| $t_{\rm f}$          | Fall Time                                   | $V_{CC}=600V,I_{C}=150A,$   | 250  |    | ns |
| Eon                  | Turn-On Switching Loss                      | $R_{G}=2.3\Omega, V_{GE}=\pm 15V, T_{j}=175^{\circ}C$   | 22.0 |    | mJ |
| $E_{ m off}$         | Turn-Off Switching Loss                     |   | 14.8 |    | mJ |
| Cies                 | Input Capacitance                           |   | 18.9 |    | nF |
| Coes                 | Output Capacitance                          | $V_{CE}=30V, f=1MHz,$   | 0.68 |    | nF |
| $C_{res}$            | Reverse Transfer Capacitance                | V <sub>GE</sub> =0V   | 0.46 |    | nF |
| $I_{SC}$             | SC Data                                     | $t_{S^{C}} \le 10 \mu s, V_{GE} = 15 V,$ $T_{j} = 125 ^{\circ}\text{C}, V_{CC} = 900 V,$ $V_{CEM} \le 1200 V$ | TBD  |    | A  |
| $R_{Gint}$           | Internal Gate Resistance                    |   | 2.5  |    | Ω  |
| L <sub>CE</sub>      | Stray Inductance                            |   |      | 20 | nН |
| R <sub>CC'+EE'</sub> | Module Lead Resistance,<br>Terminal to Chip | T <sub>C</sub> =25°C  | 0.35 |    | mΩ |

# **Electrical Characteristics of DIODE** $T_C=25$ °C unless otherwise noted

| Symbol           | Parameter        | Test Conditions       |                       | Min. | Тур. | Max. | Units |
|------------------|------------------|-----------------------|-----------------------|------|------|------|-------|
| $V_{\mathrm{F}}$ | Diode Forward    | I 150 A               | T <sub>j</sub> =25℃   |      | 1.75 | 2.15 | V     |
|                  | Voltage          | $I_F=150A$            | T <sub>j</sub> =125℃  |      | 1.80 |      |       |
| Qr               | December Change  |                       | T <sub>j</sub> =25℃   |      | 15   |      | μС    |
|                  | Recovered Charge | $I_F=150A$ ,          | T <sub>j</sub> =125℃  |      | 30   |      |       |
| T                | Peak Reverse     | $V_R = 600V$ ,        | T <sub>j</sub> =25℃   |      | 105  |      | ٨     |
| $I_{RM}$         | Recovery Current | di/dt=-1500A/μs,      | T <sub>j</sub> =125℃  |      | 140  |      | A     |
| $E_{rec}$        | Reverse Recovery | V <sub>GE</sub> =-15V | T <sub>j</sub> =25℃   |      | 7.5  |      | an I  |
|                  | Energy           |                       | T <sub>j</sub> =125 ℃ |      | 11.5 |      | mJ    |

### **Thermal Characteristics**

| Symbol          | Parameter                                     |       | Max. | Units |
|-----------------|---|-------|------|-------|
| $R_{	heta JC}$  | Junction-to-Case (IGBT Part, per 1/2 Module)  |       | 0.15 | K/W   |
| $R_{	heta JC}$  | Junction-to-Case (DIODE Part, per 1/2 Module) |       | 0.25 | K/W   |
| $R_{\theta CS}$ | Case-to-Sink (Conductive grease applied)      | 0.035 |      | K/W   |
| Weight          | Weight of Module                              | 300   |      | g     |

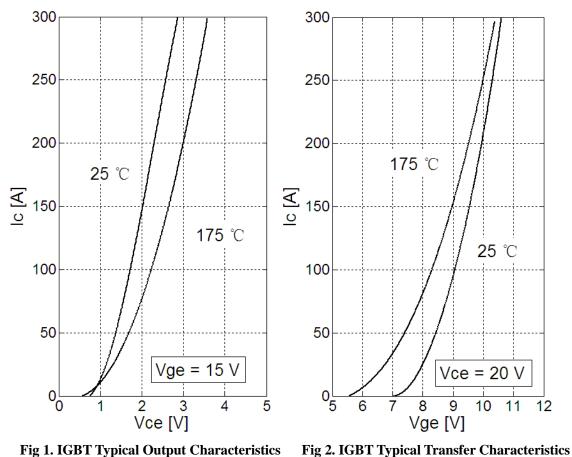


Fig 1. IGBT Typical Output Characteristics

80 50 Vcc = 600 V 45 70  $Rg = 2.3 \Omega$ Vge = ±15 V Tj = 175 ℃ 60 35 Eon 50 Eon, Eoff [mJ] Eon, Eoff [mJ] 30 Eon 25 **Eoff** 20 30 15 20 Vce = 600 V 10 **Eoff** Ic = 150 A10  $Vge = \pm 15 V$ 5 Ti = 175 ℃ 50 100 150 200 250 300 5 10 15 20 25 Ic [A]  $Rg[\Omega]$ 

Fig 3. IGBT Switching Loss vs. I<sub>C</sub>

Fig 4. IGBT Switching Loss vs. R<sub>G</sub>

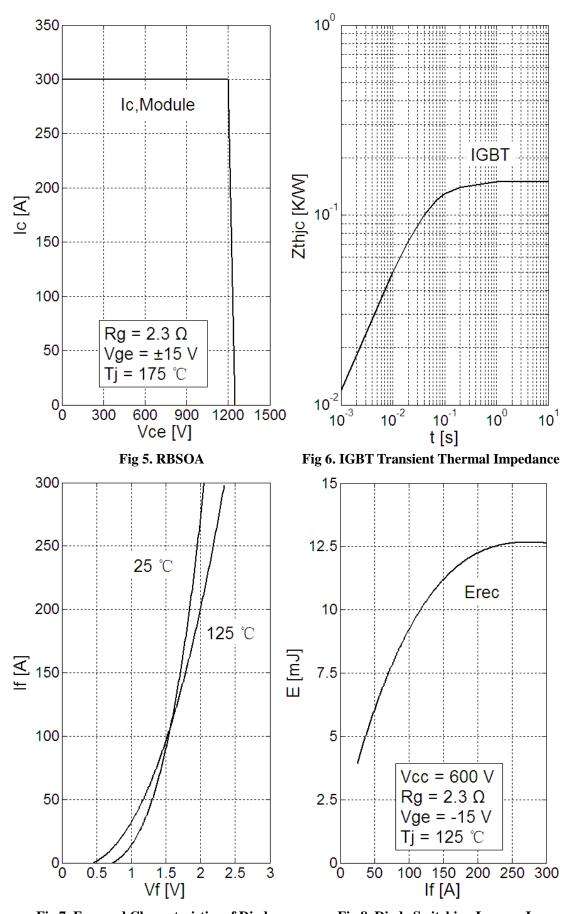


Fig 7. Forward Characteristics of Diode

Fig 8. Diode Switching Loss vs.  $I_{\rm f}$ 

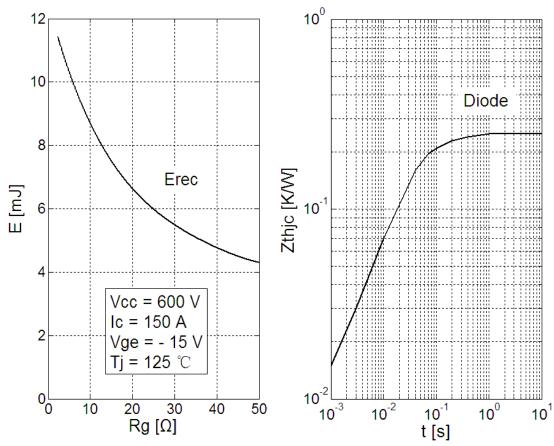
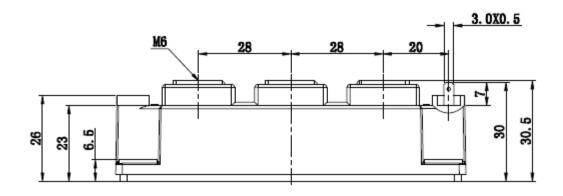


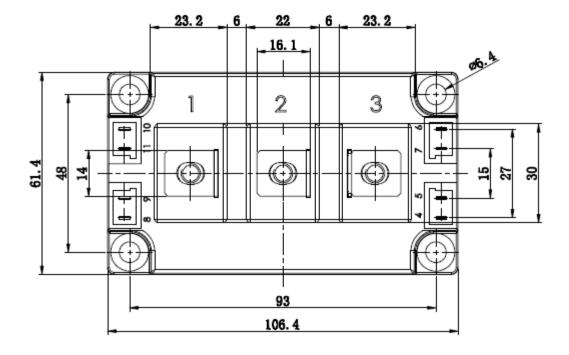
Fig 9. Diode Switching Loss vs.  $R_{\rm G}$ 

Fig 10. Diode Transient Thermal Impedance

# **Package Dimension**

#### **Dimensions in Millimeters**





GD150HFT120C2S IGBT Module

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